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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	5831
Number of Logic Elements/Cells	74637
Total RAM Bits	3170304
Number of I/O	408
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc6slx75-n3fgg676c

Quiescent Current

Typical values for quiescent supply current are specified at nominal voltage, 25°C junction temperatures (T_j). Quiescent supply current is specified by speed grade for Spartan-6 devices. Xilinx recommends analyzing static power consumption using the XPOWER™ Estimator (XPE) tool (download at <http://www.xilinx.com/power>) for conditions other than those specified in Table 5.

Table 5: Typical Quiescent Supply Current

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
I_{CCINTQ}	Quiescent V_{CCINT} supply current	LX4	4.0	4.0	4.0	2.4	mA
		LX9	4.0	4.0	4.0	2.4	mA
		LX16	6.0	6.0	6.0	4.0	mA
		LX25	11.0	11.0	11.0	6.6	mA
		LX25T	11.0	11.0	11.0	N/A	mA
		LX45	15.0	15.0	15.0	9.0	mA
		LX45T	15.0	15.0	15.0	N/A	mA
		LX75	29.0	29.0	29.0	17.4	mA
		LX75T	29.0	29.0	29.0	N/A	mA
		LX100	36.0	36.0	36.0	21.6	mA
		LX100T	36.0	36.0	36.0	N/A	mA
		LX150	51.0	51.0	51.0	31.0	mA
		LX150T	51.0	51.0	51.0	N/A	mA
I_{CCOQ}	Quiescent V_{CCO} supply current	LX4	1.0	1.0	1.0	1.0	mA
		LX9	1.0	1.0	1.0	1.0	mA
		LX16	2.0	2.0	2.0	2.0	mA
		LX25	2.0	2.0	2.0	2.0	mA
		LX25T	2.0	2.0	2.0	N/A	mA
		LX45	3.0	3.0	3.0	3.0	mA
		LX45T	3.0	3.0	3.0	N/A	mA
		LX75	4.0	4.0	4.0	4.0	mA
		LX75T	4.0	4.0	4.0	N/A	mA
		LX100	5.0	5.0	5.0	5.0	mA
		LX100T	5.0	5.0	5.0	N/A	mA
		LX150	7.0	7.0	7.0	7.0	mA
		LX150T	7.0	7.0	7.0	N/A	mA

Table 5: Typical Quiescent Supply Current (Cont'd)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
I _{CCAUXQ}	Quiescent V _{CCAUX} supply current	LX4	2.5	2.5	2.5	2.5	mA
		LX9	2.5	2.5	2.5	2.5	mA
		LX16	3.0	3.0	3.0	3.0	mA
		LX25	4.0	4.0	4.0	4.0	mA
		LX25T	4.0	4.0	4.0	N/A	mA
		LX45	5.0	5.0	5.0	5.0	mA
		LX45T	5.0	5.0	5.0	N/A	mA
		LX75	7.0	7.0	7.0	7.0	mA
		LX75T	7.0	7.0	7.0	N/A	mA
		LX100	9.0	9.0	9.0	9.0	mA
		LX100T	9.0	9.0	9.0	N/A	mA
		LX150	12.0	12.0	12.0	12.0	mA
		LX150T	12.0	12.0	12.0	N/A	mA

Notes:

- Typical values are specified at nominal voltage, 25°C junction temperatures (T_j). Industrial (I) grade devices have the same typical values as commercial (C) grade devices at 25°C, but higher values at 100°C. Use the XPE tool to calculate 100°C values. Nominal V_{CCINT} is 1.20V; use the XPE tool to calculate 1.23V values for the nominal V_{CCINT} of the extended performance range.
- Typical values are for blank configured devices with no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
- If differential signaling is used, more accurate quiescent current estimates can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

Table 6: Power Supply Ramp Time

Symbol	Description	Speed Grade	Ramp Time	Units
V _{CCINTR}	Internal supply voltage ramp time	-3, -3N, -2	0.20 to 50.0	ms
		-1L	0.20 to 40.0	ms
V _{CCO2} ⁽¹⁾	Output drivers bank 2 supply voltage ramp time	All	0.20 to 50.0	ms
V _{CCAUXR}	Auxiliary supply voltage ramp time	All	0.20 to 50.0	ms

Notes:

- The minimum V_{CCO2} for power-on reset and configuration is 1.65V.
- Spartan-6 FPGAs require a certain amount of supply current during power-on to insure proper device initialization. The actual current consumed depends on the power-on ramp rate of the power supply. Use the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools to estimate current drain on these supplies. Spartan-6 devices do not have a required power-on sequence.

Table 27: Spartan-6 Device Production Software and Speed Specification Release⁽¹⁾ (Cont'd)

Device	Speed Grade Designations ⁽²⁾			
	-3 ⁽³⁾	-3N	-2 ⁽⁴⁾	-1L
XQ6SLX75	N/A	N/A	ISE 13.2 v1.19	ISE 13.2 v1.07
XQ6SLX75T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XQ6SLX150	N/A	N/A	ISE 13.2 v1.19	ISE 13.2 v1.07
XQ6SLX150T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A

Notes:

1. ISE 13.3 software with v1.20 for -3, -3N, and -2; and v1.08 for -1L speed specification reflects the changes outlined in [XCEN11028: Spartan-6 FPGA Speed File Changes](#).
2. As marked with an N/A, LXT devices and all XA devices are not available with a -1L speed grade; LX4 devices and all XA and XQ devices are not available with a -3N speed grade.
3. Improved -3 specifications reflected in this data sheet require ISE 12.4 software with v1.15 speed specification.
4. Improved -2 specifications reflected in this data sheet require ISE 12.4 software and the *12.4 Speed Files Patch* which contains the v1.17 speed specification available on the [Xilinx Download Center](#).
5. ISE 12.3 software with v1.12 speed specification is available using ISE 12.3 software and the *12.3 Speed Files Patch* available on the [Xilinx Download Center](#).
6. ISE 12.2 software with v1.11 speed specification is available using ISE 12.2 software and the *12.2 Speed Files Patch* available on the [Xilinx Download Center](#).
7. ISE 13.1 software with v1.18 speed specification is available using ISE 13.1 software and the *13.1 Update* available on the [Xilinx Download Center](#). See [XCEN11012: Speed File Change for -3N Devices](#).

IOB Pad Input/Output/3-State Switching Characteristics

[Table 28](#) (for commercial (XC) Spartan-6 devices) and [Table 29](#) (for Automotive XA Spartan-6 and Defense-grade Spartan-6Q devices) summarizes the values of standard-specific data input delays, output delays terminating at pads (based on standard), and 3-state delays.

- T_{IOPI} is described as the delay from IOB pad through the input buffer to the I-pin of an IOB pad. The delay varies depending on the capability of the SelectIO input buffer.
- T_{IOOP} is described as the delay from the O pin to the IOB pad through the output buffer of an IOB pad. The delay varies depending on the capability of the SelectIO output buffer.
- T_{IOTP} is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is disabled. The delay varies depending on the SelectIO capability of the output buffer.

See the TRACE report for further information on delays when using an I/O standard with UNTUNED termination on inputs or outputs.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVDS_33	1.17	1.29	1.42	1.68	1.55	1.69	1.89	2.42	3000	3000	3000	3000	ns
LVDS_25	1.01	1.13	1.26	1.57	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
BLVDS_25	1.02	1.14	1.27	1.57	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
MINI_LVDS_33	1.17	1.29	1.42	1.68	1.57	1.71	1.91	2.41	3000	3000	3000	3000	ns
MINI_LVDS_25	1.01	1.13	1.26	1.57	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
LVPECL_33	1.18	1.30	1.43	1.68	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns
LVPECL_25	1.02	1.14	1.27	1.57	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns
RSDS_33 (point to point)	1.17	1.29	1.42	1.68	1.57	1.71	1.91	2.42	3000	3000	3000	3000	ns
RSDS_25 (point to point)	1.01	1.13	1.26	1.56	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
TMDS_33	1.21	1.33	1.46	1.71	1.54	1.68	1.88	2.50	3000	3000	3000	3000	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS15, Slow, 8 mA	0.98	1.10	1.23	1.79	2.30	2.44	2.64	3.25	2.30	2.44	2.64	3.25	ns
LVC MOS15, Slow, 12 mA	0.98	1.10	1.23	1.79	2.03	2.17	2.37	2.99	2.03	2.17	2.37	2.99	ns
LVC MOS15, Slow, 16 mA	0.98	1.10	1.23	1.79	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15, Fast, 2 mA	0.98	1.10	1.23	1.79	3.29	3.43	3.63	4.24	3.29	3.43	3.63	4.24	ns
LVC MOS15, Fast, 4 mA	0.98	1.10	1.23	1.79	2.27	2.41	2.61	3.22	2.27	2.41	2.61	3.22	ns
LVC MOS15, Fast, 6 mA	0.98	1.10	1.23	1.79	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15, Fast, 8 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15, Fast, 12 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15, Fast, 16 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15_JEDEC, QUIETIO, 2 mA	1.03	1.15	1.28	1.49	5.49	5.63	5.83	6.37	5.49	5.63	5.83	6.37	ns
LVC MOS15_JEDEC, QUIETIO, 4 mA	1.03	1.15	1.28	1.49	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15_JEDEC, QUIETIO, 6 mA	1.03	1.15	1.28	1.49	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15_JEDEC, QUIETIO, 8 mA	1.03	1.15	1.28	1.49	3.92	4.06	4.26	4.81	3.92	4.06	4.26	4.81	ns
LVC MOS15_JEDEC, QUIETIO, 12 mA	1.03	1.15	1.28	1.49	3.54	3.68	3.88	4.51	3.54	3.68	3.88	4.51	ns
LVC MOS15_JEDEC, QUIETIO, 16 mA	1.03	1.15	1.28	1.49	3.33	3.47	3.67	4.31	3.33	3.47	3.67	4.31	ns
LVC MOS15_JEDEC, Slow, 2 mA	1.03	1.15	1.28	1.49	4.18	4.32	4.52	5.13	4.18	4.32	4.52	5.13	ns
LVC MOS15_JEDEC, Slow, 4 mA	1.03	1.15	1.28	1.49	3.42	3.56	3.76	4.35	3.42	3.56	3.76	4.35	ns
LVC MOS15_JEDEC, Slow, 6 mA	1.03	1.15	1.28	1.49	2.29	2.43	2.63	3.25	2.29	2.43	2.63	3.25	ns
LVC MOS15_JEDEC, Slow, 8 mA	1.03	1.15	1.28	1.49	2.30	2.44	2.64	3.26	2.30	2.44	2.64	3.26	ns
LVC MOS15_JEDEC, Slow, 12 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Slow, 16 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Fast, 2 mA	1.03	1.15	1.28	1.49	3.28	3.42	3.62	4.22	3.28	3.42	3.62	4.22	ns
LVC MOS15_JEDEC, Fast, 4 mA	1.03	1.15	1.28	1.49	2.27	2.41	2.61	3.23	2.27	2.41	2.61	3.23	ns
LVC MOS15_JEDEC, Fast, 6 mA	1.03	1.15	1.28	1.49	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15_JEDEC, Fast, 8 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15_JEDEC, Fast, 12 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS15_JEDEC, Fast, 16 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS12, QUIETIO, 2 mA	0.91	1.03	1.16	1.51	6.40	6.54	6.74	7.30	6.40	6.54	6.74	7.30	ns
LVC MOS12, QUIETIO, 4 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.90	4.98	5.12	5.32	5.90	ns
LVC MOS12, QUIETIO, 6 mA	0.91	1.03	1.16	1.51	4.65	4.79	4.99	5.55	4.65	4.79	4.99	5.55	ns
LVC MOS12, QUIETIO, 8 mA	0.91	1.03	1.16	1.51	4.23	4.37	4.57	5.21	4.23	4.37	4.57	5.21	ns
LVC MOS12, QUIETIO, 12 mA	0.91	1.03	1.16	1.51	3.98	4.12	4.32	4.94	3.98	4.12	4.32	4.94	ns
LVC MOS12, Slow, 2 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.91	4.98	5.12	5.32	5.91	ns
LVC MOS12, Slow, 4 mA	0.91	1.03	1.16	1.51	2.84	2.98	3.18	3.81	2.84	2.98	3.18	3.81	ns
LVC MOS12, Slow, 6 mA	0.91	1.03	1.16	1.51	2.77	2.91	3.11	3.72	2.77	2.91	3.11	3.72	ns
LVC MOS12, Slow, 8 mA	0.91	1.03	1.16	1.51	2.34	2.48	2.68	3.31	2.34	2.48	2.68	3.31	ns
LVC MOS12, Slow, 12 mA	0.91	1.03	1.16	1.51	2.08	2.22	2.42	3.06	2.08	2.22	2.42	3.06	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS12, Fast, 2 mA	0.91	1.03	1.16	1.51	3.46	3.60	3.80	4.44	3.46	3.60	3.80	4.44	ns
LVC MOS12, Fast, 4 mA	0.91	1.03	1.16	1.51	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12, Fast, 6 mA	0.91	1.03	1.16	1.51	1.79	1.93	2.13	2.75	1.79	1.93	2.13	2.75	ns
LVC MOS12, Fast, 8 mA	0.91	1.03	1.16	1.51	1.68	1.82	2.02	2.64	1.68	1.82	2.02	2.64	ns
LVC MOS12, Fast, 12 mA	0.91	1.03	1.16	1.51	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns
LVC MOS12_JEDEC, QUIETIO, 2 mA	1.50	1.62	1.75	1.88	6.39	6.53	6.73	7.31	6.39	6.53	6.73	7.31	ns
LVC MOS12_JEDEC, QUIETIO, 4 mA	1.50	1.62	1.75	1.88	4.98	5.12	5.32	5.88	4.98	5.12	5.32	5.88	ns
LVC MOS12_JEDEC, QUIETIO, 6 mA	1.50	1.62	1.75	1.88	4.67	4.81	5.01	5.54	4.67	4.81	5.01	5.54	ns
LVC MOS12_JEDEC, QUIETIO, 8 mA	1.50	1.62	1.75	1.88	4.23	4.37	4.57	5.22	4.23	4.37	4.57	5.22	ns
LVC MOS12_JEDEC, QUIETIO, 12 mA	1.50	1.62	1.75	1.88	3.99	4.13	4.33	4.94	3.99	4.13	4.33	4.94	ns
LVC MOS12_JEDEC, Slow, 2 mA	1.50	1.62	1.75	1.88	5.00	5.14	5.34	5.90	5.00	5.14	5.34	5.90	ns
LVC MOS12_JEDEC, Slow, 4 mA	1.50	1.62	1.75	1.88	2.85	2.99	3.19	3.80	2.85	2.99	3.19	3.80	ns
LVC MOS12_JEDEC, Slow, 6 mA	1.50	1.62	1.75	1.88	2.76	2.90	3.10	3.72	2.76	2.90	3.10	3.72	ns
LVC MOS12_JEDEC, Slow, 8 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12_JEDEC, Slow, 12 mA	1.50	1.62	1.75	1.88	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS12_JEDEC, Fast, 2 mA	1.50	1.62	1.75	1.88	3.46	3.60	3.80	4.42	3.46	3.60	3.80	4.42	ns
LVC MOS12_JEDEC, Fast, 4 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.31	2.35	2.49	2.69	3.31	ns
LVC MOS12_JEDEC, Fast, 6 mA	1.50	1.62	1.75	1.88	1.79	1.93	2.13	2.76	1.79	1.93	2.13	2.76	ns
LVC MOS12_JEDEC, Fast, 8 mA	1.50	1.62	1.75	1.88	1.69	1.83	2.03	2.65	1.69	1.83	2.03	2.65	ns
LVC MOS12_JEDEC, Fast, 12 mA	1.50	1.62	1.75	1.88	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns

Notes:

1. The -1L values listed in this table are also applicable to the Spartan-6Q devices.
2. Devices with a -1L speed grade do not support Xilinx PCI IP.

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
DIFF_SSTL3_I	1.26	1.44	1.95	2.15	1.95	2.15	ns
DIFF_SSTL3_II	1.26	1.44	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_I	1.09	1.27	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_II	1.09	1.27	1.90	2.10	1.90	2.10	ns
DIFF_SSTL18_I	1.04	1.22	1.86	2.06	1.86	2.06	ns
DIFF_SSTL18_II	1.05	1.23	1.82	2.02	1.82	2.02	ns
DIFF_SSTL15_II	1.01	1.19	1.81	2.01	1.81	2.01	ns
DIFF_MOBILE_DDR	1.04	1.22	1.89	2.09	1.89	2.09	ns
LVTTL, QUIETIO, 2 mA	1.42	1.60	5.64	5.84	5.64	5.84	ns
LVTTL, QUIETIO, 4 mA	1.42	1.60	4.46	4.66	4.46	4.66	ns
LVTTL, QUIETIO, 6 mA	1.42	1.60	3.92	4.12	3.92	4.12	ns
LVTTL, QUIETIO, 8 mA	1.42	1.60	3.37	3.57	3.37	3.57	ns
LVTTL, QUIETIO, 12 mA	1.42	1.60	3.42	3.62	3.42	3.62	ns
LVTTL, QUIETIO, 16 mA	1.42	1.60	3.09	3.29	3.09	3.29	ns
LVTTL, QUIETIO, 24 mA	1.42	1.60	2.83	3.03	2.83	3.03	ns
LVTTL, Slow, 2 mA	1.42	1.60	4.58	4.78	4.58	4.78	ns
LVTTL, Slow, 4 mA	1.42	1.60	3.38	3.58	3.38	3.58	ns
LVTTL, Slow, 6 mA	1.42	1.60	2.95	3.15	2.95	3.15	ns
LVTTL, Slow, 8 mA	1.42	1.60	2.73	2.93	2.73	2.93	ns
LVTTL, Slow, 12 mA	1.42	1.60	2.72	2.92	2.72	2.92	ns
LVTTL, Slow, 16 mA	1.42	1.60	2.53	2.73	2.53	2.73	ns
LVTTL, Slow, 24 mA	1.42	1.60	2.42	2.62	2.42	2.62	ns
LVTTL, Fast, 2 mA	1.42	1.60	4.04	4.24	4.04	4.24	ns
LVTTL, Fast, 4 mA	1.42	1.60	2.66	2.86	2.66	2.86	ns
LVTTL, Fast, 6 mA	1.42	1.60	2.58	2.78	2.58	2.78	ns
LVTTL, Fast, 8 mA	1.42	1.60	2.46	2.66	2.46	2.66	ns
LVTTL, Fast, 12 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 16 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 24 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVC MOS33, QUIETIO, 2 mA	1.41	1.59	5.65	5.85	5.65	5.85	ns
LVC MOS33, QUIETIO, 4 mA	1.41	1.59	4.20	4.40	4.20	4.40	ns
LVC MOS33, QUIETIO, 6 mA	1.41	1.59	3.65	3.85	3.65	3.85	ns
LVC MOS33, QUIETIO, 8 mA	1.41	1.59	3.51	3.71	3.51	3.71	ns
LVC MOS33, QUIETIO, 12 mA	1.41	1.59	3.09	3.29	3.09	3.29	ns
LVC MOS33, QUIETIO, 16 mA	1.41	1.59	2.91	3.11	2.91	3.11	ns
LVC MOS33, QUIETIO, 24 mA	1.41	1.59	2.73	2.93	2.73	2.93	ns
LVC MOS33, Slow, 2 mA	1.41	1.59	4.59	4.79	4.59	4.79	ns
LVC MOS33, Slow, 4 mA	1.41	1.59	3.14	3.34	3.14	3.34	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS33, Slow, 6 mA	1.41	1.59	2.79	2.99	2.79	2.99	ns
LVC MOS33, Slow, 8 mA	1.41	1.59	2.79	2.99	2.79	2.99	ns
LVC MOS33, Slow, 12 mA	1.41	1.59	2.53	2.73	2.53	2.73	ns
LVC MOS33, Slow, 16 mA	1.41	1.59	2.45	2.65	2.45	2.65	ns
LVC MOS33, Slow, 24 mA	1.41	1.59	2.42	2.62	2.42	2.62	ns
LVC MOS33, Fast, 2 mA	1.41	1.59	4.05	4.25	4.05	4.25	ns
LVC MOS33, Fast, 4 mA	1.41	1.59	2.66	2.86	2.66	2.86	ns
LVC MOS33, Fast, 6 mA	1.41	1.59	2.46	2.66	2.46	2.66	ns
LVC MOS33, Fast, 8 mA	1.41	1.59	2.21	2.41	2.21	2.41	ns
LVC MOS33, Fast, 12 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS33, Fast, 16 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS33, Fast, 24 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS25, QUIETIO, 2 mA	0.89	1.07	5.00	5.20	5.00	5.20	ns
LVC MOS25, QUIETIO, 4 mA	0.89	1.07	3.85	4.05	3.85	4.05	ns
LVC MOS25, QUIETIO, 6 mA	0.89	1.07	3.60	3.80	3.60	3.80	ns
LVC MOS25, QUIETIO, 8 mA	0.89	1.07	3.34	3.54	3.34	3.54	ns
LVC MOS25, QUIETIO, 12 mA	0.89	1.07	2.98	3.18	2.98	3.18	ns
LVC MOS25, QUIETIO, 16 mA	0.89	1.07	2.79	2.99	2.79	2.99	ns
LVC MOS25, QUIETIO, 24 mA	0.89	1.07	2.64	2.84	2.64	2.84	ns
LVC MOS25, Slow, 2 mA	0.89	1.07	3.96	4.16	3.96	4.16	ns
LVC MOS25, Slow, 4 mA	0.89	1.07	2.96	3.16	2.96	3.16	ns
LVC MOS25, Slow, 6 mA	0.89	1.07	2.88	3.08	2.88	3.08	ns
LVC MOS25, Slow, 8 mA	0.89	1.07	2.63	2.83	2.63	2.83	ns
LVC MOS25, Slow, 12 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Slow, 16 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Slow, 24 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Fast, 2 mA	0.89	1.07	3.52	3.72	3.52	3.72	ns
LVC MOS25, Fast, 4 mA	0.89	1.07	2.43	2.63	2.43	2.63	ns
LVC MOS25, Fast, 6 mA	0.89	1.07	2.23	2.43	2.23	2.43	ns
LVC MOS25, Fast, 8 mA	0.89	1.07	2.16	2.36	2.16	2.36	ns
LVC MOS25, Fast, 12 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS25, Fast, 16 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS25, Fast, 24 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS18, QUIETIO, 2 mA	1.25	1.43	6.11	6.31	6.11	6.31	ns
LVC MOS18, QUIETIO, 4 mA	1.25	1.43	4.88	5.08	4.88	5.08	ns
LVC MOS18, QUIETIO, 6 mA	1.25	1.43	4.20	4.40	4.20	4.40	ns
LVC MOS18, QUIETIO, 8 mA	1.25	1.43	3.86	4.06	3.86	4.06	ns
LVC MOS18, QUIETIO, 12 mA	1.25	1.43	3.49	3.69	3.49	3.69	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS15, QUIETIO, 2 mA	1.05	1.23	5.63	5.83	5.63	5.83	ns
LVC MOS15, QUIETIO, 4 mA	1.05	1.23	4.75	4.95	4.75	4.95	ns
LVC MOS15, QUIETIO, 6 mA	1.05	1.23	4.21	4.41	4.21	4.41	ns
LVC MOS15, QUIETIO, 8 mA	1.05	1.23	4.05	4.25	4.05	4.25	ns
LVC MOS15, QUIETIO, 12 mA	1.05	1.23	3.74	3.94	3.74	3.94	ns
LVC MOS15, QUIETIO, 16 mA	1.05	1.23	3.52	3.72	3.52	3.72	ns
LVC MOS15, Slow, 2 mA	1.05	1.23	4.32	4.52	4.32	4.52	ns
LVC MOS15, Slow, 4 mA	1.05	1.23	3.58	3.78	3.58	3.78	ns
LVC MOS15, Slow, 6 mA	1.05	1.23	2.45	2.65	2.45	2.65	ns
LVC MOS15, Slow, 8 mA	1.05	1.23	2.46	2.66	2.46	2.66	ns
LVC MOS15, Slow, 12 mA	1.05	1.23	2.17	2.37	2.17	2.37	ns
LVC MOS15, Slow, 16 mA	1.05	1.23	2.15	2.35	2.15	2.35	ns
LVC MOS15, Fast, 2 mA	1.05	1.23	3.43	3.63	3.43	3.63	ns
LVC MOS15, Fast, 4 mA	1.05	1.23	2.42	2.62	2.42	2.62	ns
LVC MOS15, Fast, 6 mA	1.05	1.23	1.92	2.12	1.92	2.12	ns
LVC MOS15, Fast, 8 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15, Fast, 12 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15, Fast, 16 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, QUIETIO, 2 mA	1.10	1.28	5.64	5.84	5.64	5.84	ns
LVC MOS15_JEDEC, QUIETIO, 4 mA	1.10	1.28	4.75	4.95	4.75	4.95	ns
LVC MOS15_JEDEC, QUIETIO, 6 mA	1.10	1.28	4.21	4.41	4.21	4.41	ns
LVC MOS15_JEDEC, QUIETIO, 8 mA	1.10	1.28	4.06	4.26	4.06	4.26	ns
LVC MOS15_JEDEC, QUIETIO, 12 mA	1.10	1.28	3.75	3.95	3.75	3.95	ns
LVC MOS15_JEDEC, QUIETIO, 16 mA	1.10	1.28	3.53	3.73	3.53	3.73	ns
LVC MOS15_JEDEC, Slow, 2 mA	1.10	1.28	4.32	4.52	4.32	4.52	ns
LVC MOS15_JEDEC, Slow, 4 mA	1.10	1.28	3.56	3.76	3.56	3.76	ns
LVC MOS15_JEDEC, Slow, 6 mA	1.10	1.28	2.44	2.64	2.44	2.64	ns
LVC MOS15_JEDEC, Slow, 8 mA	1.10	1.28	2.47	2.67	2.47	2.67	ns
LVC MOS15_JEDEC, Slow, 12 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns
LVC MOS15_JEDEC, Slow, 16 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns
LVC MOS15_JEDEC, Fast, 2 mA	1.10	1.28	3.43	3.63	3.43	3.63	ns
LVC MOS15_JEDEC, Fast, 4 mA	1.10	1.28	2.42	2.62	2.42	2.62	ns
LVC MOS15_JEDEC, Fast, 6 mA	1.10	1.28	1.92	2.12	1.92	2.12	ns
LVC MOS15_JEDEC, Fast, 8 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, Fast, 12 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, Fast, 16 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS12, QUIETIO, 2 mA	0.98	1.16	6.54	6.74	6.54	6.74	ns
LVC MOS12, QUIETIO, 4 mA	0.98	1.16	5.12	5.32	5.12	5.32	ns

I/O Standard Measurement Methodology

Input Delay Measurements

Table 31 shows the test setup parameters used for measuring input delay.

Table 31: Input Delay Measurement Methodology

Description	I/O Standard Attribute	$V_L^{(1)}$	$V_H^{(1)}$	$V_{MEAS}^{(3)(4)}$	$V_{REF}^{(2)(4)}$
LVTTTL (Low-Voltage Transistor-Transistor Logic)	LVTTTL	0	3.0	1.4	—
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	0	3.3	1.65	—
LVC MOS, 2.5V	LVC MOS25	0	2.5	1.25	—
LVC MOS, 1.8V	LVC MOS18	0	1.8	0.9	—
LVC MOS, 1.5V	LVC MOS15	0	1.5	0.75	—
LVC MOS, 1.2V	LVC MOS12	0	1.2	0.6	—
PCI (Peripheral Component Interface), 33 MHz and 66 MHz, 3.3V	PCI33_3, PCI66_3	Per PCI Specification			—
HSTL (High-Speed Transceiver Logic), Class I & II	HSTL_I, HSTL_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.75
HSTL, Class III	HSTL_III	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class I & II, 1.8V	HSTL_I_18, HSTL_II_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class III 1.8V	HSTL_III_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	1.1
SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V	SSTL3_I, SSTL3_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.5
SSTL, Class I & II, 2.5V	SSTL2_I, SSTL2_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.25
SSTL, Class I & II, 1.8V	SSTL18_I, SSTL18_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
SSTL, Class II, 1.5V	SSTL15_II	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	0.75
LVDS (Low-Voltage Differential Signaling), 2.5V & 3.3V	LVDS_25, LVDS_33	$1.25 - 0.125$	$1.25 + 0.125$	0 ⁽⁵⁾	—
LVPECL (Low-Voltage Positive Emitter-Coupled Logic), 2.5V & 3.3V	LVPECL_25, LVPECL_33	$1.2 - 0.3$	$1.2 + 0.3$	0 ⁽⁵⁾	—
BLVDS (Bus LVDS), 2.5V	BLVDS_25	$1.3 - 0.125$	$1.3 + 0.125$	0 ⁽⁵⁾	—
Mini-LVDS, 2.5V & 3.3V	MINI_LVDS_25, MINI_LVDS_33	$1.2 - 0.125$	$1.2 + 0.125$	0 ⁽⁵⁾	—
RS DS (Reduced Swing Differential Signaling), 2.5V & 3.3V	RS DS_25, RS DS_33	$1.2 - 0.1$	$1.2 + 0.1$	0 ⁽⁵⁾	—
TMDS (Transition Minimized Differential Signaling), 3.3V	TMDS_33	$3.0 - 0.1$	$3.0 + 0.1$	0 ⁽⁵⁾	—
PPDS (Point-to-Point Differential Signaling), 2.5V & 3.3V	PPDS_25, PPDS_33	$1.25 - 0.1$	$1.25 + 0.1$	0 ⁽⁵⁾	—

Notes:

1. Input waveform switches between V_L and V_H .
2. Measurements are made at typical, minimum, and maximum V_{REF} values. Reported delays reflect worst case of these measurements. V_{REF} values listed are typical.
3. Input voltage level from which measurement starts.
4. This is an input voltage reference that bears no relation to the V_{REF} / V_{MEAS} parameters found in IBIS models and/or noted in Figure 4.
5. The value given is the differential input voltage.

Table 32: Output Delay Measurement Methodology (Cont'd)

Description	I/O Standard Attribute	R_{REF} (Ω)	$C_{REF}^{(1)}$ (pF)	V_{MEAS} (V)	V_{REF} (V)
SSTL, Class II, 2.5V	SSTL2_II	25	0	V_{REF}	1.25
SSTL, Class II, 1.5V	SSTL15_II	25	0	V_{REF}	0.75
LVDS (Low-Voltage Differential Signaling), 2.5V & 3.3V	LVDS_25, LVDS_33	100	0	0 ⁽³⁾	—
BLVDS (Bus LVDS), 2.5V	BLVDS_25	Note 4	0	0 ⁽³⁾	—
Mini-LVDS, 2.5V & 3.3V	MINI_LVDS_25, MINI_LVDS_33	100	0	0 ⁽³⁾	—
RSDS (Reduced Swing Differential Signaling), 2.5V & 3.3V	RSDS_25, RSDS_33	100	0	0 ⁽³⁾	—
TMDS (Transition Minimized Differential Signaling), 3.3V	TMDS_33	Note 5	0	0 ⁽³⁾	—
PPDS (Point-to-Point Differential Signaling, 2.5V & 3.3V	PPDS_25, PPDS_33	100	0	0 ⁽³⁾	—

Notes:

1. C_{REF} is the capacitance of the probe, nominally 0 pF.
2. Per PCI specifications.
3. The value given is the differential output voltage.
4. See the *BLVDS Output Termination* section in [UG381](#), *Spartan-6 FPGA SelectIO Resources User Guide*.
5. See the *TMDS_33 Termination* section in [UG381](#), *Spartan-6 FPGA SelectIO Resources User Guide*.

Simultaneously Switching Outputs

Due to package electrical parasitics, a given package supports a limited number of simultaneous switching outputs (SSOs) when using fast, high-drive outputs. [Table 33](#) and [Table 34](#) provide guidelines for the recommended maximum allowable number of SSOs. These guidelines describe the maximum number of user I/O pins of an output signal standard that should simultaneously switch in the same direction, while maintaining a safe level of switching noise for that particular signal standard. Meeting these guidelines for the stated test conditions ensures that the FPGA operates free from the adverse effects of GND and power bounce.

For each device/package combination, [Table 33](#) provides the number of equivalent V_{CCO}/GND pairs per bank. For each output signal standard and drive strength, [Table 34](#) recommends the maximum number of SSOs, switching in the same direction, allowed per V_{CCO}/GND pair within an I/O bank. The guidelines are categorized by package style, slew rate, and output drive current. The number of SSOs are also specified by I/O bank. Multiply the appropriate numbers from each table to calculate the maximum number of SSOs allowed within an I/O bank. The guidelines assume that all pins within a bank use the same I/O standard. Exceeding these SSO guidelines can result in increased power or GND bounce, degraded signal integrity, or increased system jitter. For a given I/O standard, if the SSO limit per pair in [Table 34](#) is greater than the maximum I/O per pair in [Table 33](#), then there is no SSO limit for the exclusive use of that I/O standard.

The recommended maximum SSO values assume that the FPGA is soldered on a printed circuit board and that the board uses sound design practices. Due to the additional inductance introduced by the socket, the SSO values do not apply for FPGAs mounted in sockets. The SSO values assume that the V_{CCAUX} is powered at 3.3V. Setting V_{CCAUX} to 2.5V provides better SSO characteristics. For more detail, see [UG381](#): *Spartan-6 FPGA SelectIO Resources User Guide*.

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.5V	LVCMOS15, LVCMOS15_JEDEC	2	Fast	33	40	33	41
			Slow	57	62	57	56
			QuietIO	70	67	70	66
		4	Fast	19	21	19	21
			Slow	30	30	30	24
			QuietIO	38	33	38	30
		6	Fast	14	16	14	16
			Slow	18	19	18	17
			QuietIO	27	24	27	21
		8	Fast	11	13	11	12
			Slow	16	16	16	14
			QuietIO	23	20	23	17
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	10	N/A	9
		16	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	8
			QuietIO	N/A	10	N/A	9
	HSTL_I			9	10	9	10
	HSTL_II			N/A	5	N/A	6
	HSTL_III			7	9	7	9
	DIFF_HSTL_I			27	30	27	30
	DIFF_HSTL_II			N/A	15	N/A	18
	DIFF_HSTL_III			21	27	21	27
	SSTL_15_II ⁽³⁾			N/A	5	N/A	4
	DIFF_SSTL_15_II ⁽³⁾			N/A	15	N/A	12

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair				
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324		
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5	
1.8V	LVCMOS18, LVCMOS18_JEDEC	2	Fast	39	46	39	47	
			Slow	65	75	65	74	
			QuietIO	80	80	80	85	
		4	Fast	22	25	22	25	
			Slow	38	36	38	29	
			QuietIO	45	40	45	35	
		6	Fast	16	18	16	17	
			Slow	27	25	27	19	
			QuietIO	30	28	30	23	
		8	Fast	13	15	13	14	
			Slow	16	18	16	16	
			QuietIO	25	22	25	18	
		12	Fast	5	7	5	5	
			Slow	7	8	7	6	
			QuietIO	11	10	11	8	
		16	Fast	4	5	4	4	
			Slow	7	8	7	5	
			QuietIO	11	10	11	8	
		24	Fast	N/A	5	N/A	3	
			Slow	N/A	8	N/A	8	
			QuietIO	N/A	10	N/A	8	
	HSTL_I_18				9	10	9	9
	HSTL_II_18				N/A	5	N/A	6
	HSTL_III_18				9	10	9	11
	DIFF_HSTL_I_18				27	30	27	27
	DIFF_HSTL_II_18				N/A	15	N/A	18
	DIFF_HSTL_III_18				27	30	27	33
	MOBILE_DDR ⁽³⁾				12	14	12	14
	DIFF_MOBILE_DDR ⁽³⁾				36	42	36	42
	SSTL_18_I ⁽³⁾				9	10	9	10
	SSTL_18_II ⁽³⁾				N/A	5	N/A	4
	DIFF_SSTL_18_I ⁽³⁾				27	30	27	30
	DIFF_SSTL_18_II ⁽³⁾				N/A	15	N/A	12

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
3.3V	LVCMOS33	2	Fast	42	46	42	44
			Slow	50	55	50	49
			QuietIO	60	68	60	60
		4	Fast	21	27	21	25
			Slow	32	37	32	32
			QuietIO	39	42	39	37
		6	Fast	14	19	14	17
			Slow	19	25	19	22
			QuietIO	29	30	29	25
		8	Fast	11	15	11	14
			Slow	15	20	15	18
			QuietIO	25	24	25	20
		12	Fast	1	3	1	1
			Slow	2	5	2	2
			QuietIO	4	9	4	7
		16	Fast	1	2	1	1
			Slow	1	5	1	1
			QuietIO	3	10	3	8
		24	Fast	1	2	1	1
			Slow	2	5	2	1
			QuietIO	7	9	7	7

Table 57: Switching Characteristics for the Digital Frequency Synthesizer DFS (DCM_CLKGEN)⁽¹⁾ (Cont'd)

Symbol	Description	Speed Grade								Units
		-3		-3N		-2		-1L		
		Min	Max	Min	Max	Min	Max	Min	Max	
Spread Spectrum										
F _{CLKIN_FIXED_SPREAD_SPECTRUM}	Frequency of the CLKIN input for fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD/ CENTER_HIGH_SPREAD)	30	200	30	200	30	200	30	200	MHz
T _{CENTER_LOW_SPREAD} ⁽⁶⁾	Spread at the CLKFX output for fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD)	Typical = $\frac{100}{\text{CLKFX_DIVIDE}}$ Maximum = 250								ps
T _{CENTER_HIGH_SPREAD} ⁽⁶⁾	Spread at the CLKFX output for fixed spread spectrum (SPREAD_SPECTRUM= CENTER_HIGH_SPREAD)	Typical = $\frac{240}{\text{CLKFX_DIVIDE}}$ Maximum = 400								ps
F _{MOD_FIXED_SPREAD_SPECTRUM} ⁽⁶⁾	Average modulation frequency when using fixed spread spectrum (SPREAD_SPECTRUM = CENTER_LOW_SPREAD / CENTER_HIGH_SPREAD)	Typical = F _{IN} /1024								MHz

Notes:

- The values in this table are based on the operating conditions described in Table 2 and Table 55.
- For optimal jitter tolerance and a faster LOCK time, use the CLKIN_PERIOD attribute.
- Output jitter is characterized with no input jitter. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply, and PCB design. The actual maximum output jitter depends on the system application.
- The CLKFX, CLKFXDV, and CLKFX180 outputs have a duty cycle of approximately 50%.
- Some duty-cycle and alignment specifications include a percentage of the CLKFX output period. For example, this data sheet specifies a maximum CLKFX jitter of $\pm(1\% \text{ of CLKFX period} + 200 \text{ ps})$. Assuming that the CLKFX output frequency is 100 MHz, the equivalent CLKFX period is 10 ns, and 1% of 10 ns is 0.1 ns or 100 ps. Accordingly, the maximum jitter is $\pm(100 \text{ ps} + 200 \text{ ps}) = \pm 300 \text{ ps}$.
- When using CENTER_LOW_SPREAD, CENTER_HIGH_SPREAD, the valid values for CLKFX_MULTIPLY are limited to 2 through 32, and the valid values for CLKFX_DIVIDE are limited to 1 through 4.

Table 58: Recommended Operating Conditions for the Phase-Shift Clock in Variable Phase Mode (DCM_SP) or Dynamic Frequency Synthesis (DCM_CLKGEN)

Symbol	Description	Speed Grade								Units
		-3		-3N		-2		-1L		
		Min	Max	Min	Max	Min	Max	Min	Max	
Operating Frequency Ranges										
PSCLK_FREQ	Frequency for the PSCLK (DCM_SP) or PROGCLK (DCM_CLKGEN) input.	1	167	1	167	1	167	1	100	MHz
Input Pulse Requirements										
PSCLK_PULSE	PSCLK (DCM_SP) or PROGCLK (DCM_CLKGEN) pulse width as a percentage of the clock period.	40	60	40	60	40	60	40	60	%

Table 65: Global Clock Input to Output Delay With DCM in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in Source-Synchronous Mode.							
T _{ICKOFDCM_0}	Global Clock and OUTFF <i>with</i> DCM	XC6SLX4	5.03	N/A	7.21	8.05	ns
		XC6SLX9	5.03	6.13	7.21	8.05	ns
		XC6SLX16	5.08	5.51	6.44	7.96	ns
		XC6SLX25	4.81	5.13	5.69	7.94	ns
		XC6SLX25T	4.81	5.13	5.69	N/A	ns
		XC6SLX45	5.26	5.69	6.63	7.92	ns
		XC6SLX45T	5.26	5.69	6.63	N/A	ns
		XC6SLX75	4.77	5.18	5.88	7.95	ns
		XC6SLX75T	4.77	5.18	5.88	N/A	ns
		XC6SLX100	4.72	5.11	5.76	8.59	ns
		XC6SLX100T	4.76	5.11	5.76	N/A	ns
		XC6SLX150	4.90	5.30	5.93	7.93	ns
		XC6SLX150T	4.90	5.30	5.93	N/A	ns
		XA6SLX4	5.35	N/A	7.21	N/A	ns
		XA6SLX9	5.35	N/A	7.21	N/A	ns
		XA6SLX16	5.42	N/A	6.44	N/A	ns
		XA6SLX25	5.13	N/A	5.69	N/A	ns
		XA6SLX25T	5.13	N/A	5.79	N/A	ns
		XA6SLX45	5.58	N/A	6.63	N/A	ns
		XA6SLX45T	5.58	N/A	6.63	N/A	ns
		XA6SLX75	5.09	N/A	5.87	N/A	ns
		XA6SLX75T	5.09	N/A	5.87	N/A	ns
		XA6SLX100	N/A	N/A	6.44	N/A	ns
		XQ6SLX75	N/A	N/A	5.87	7.95	ns
		XQ6SLX75T	5.09	N/A	5.87	N/A	ns
		XQ6SLX150	N/A	N/A	6.06	7.93	ns
		XQ6SLX150T	5.50	N/A	6.06	N/A	ns

Notes:

- Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
- DCM output jitter is already included in the timing calculation.

Table 67: Global Clock Input to Output Delay With PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> PLL in Source-Synchronous Mode.							
T _{ICKOFFLL_0}	Global Clock and OUTFF <i>with</i> PLL	XC6SLX4	5.49	N/A	7.44	8.55	ns
		XC6SLX9	5.49	6.29	7.44	8.55	ns
		XC6SLX16	5.23	5.77	6.79	8.21	ns
		XC6SLX25	5.00	5.35	6.10	8.54	ns
		XC6SLX25T	5.00	5.35	6.10	N/A	ns
		XC6SLX45	5.59	6.03	7.02	8.39	ns
		XC6SLX45T	5.59	6.03	7.02	N/A	ns
		XC6SLX75	4.96	5.41	6.22	8.32	ns
		XC6SLX75T	4.96	5.41	6.22	N/A	ns
		XC6SLX100	4.97	5.42	6.21	9.08	ns
		XC6SLX100T	5.01	5.42	6.21	N/A	ns
		XC6SLX150	4.59	5.06	5.86	8.13	ns
		XC6SLX150T	4.59	5.06	5.86	N/A	ns
		XA6SLX4	5.79	N/A	7.32	N/A	ns
		XA6SLX9	5.79	N/A	7.32	N/A	ns
		XA6SLX16	5.56	N/A	6.66	N/A	ns
		XA6SLX25	5.40	N/A	5.97	N/A	ns
		XA6SLX25T	5.40	N/A	6.07	N/A	ns
		XA6SLX45	5.89	N/A	6.90	N/A	ns
		XA6SLX45T	5.89	N/A	6.90	N/A	ns
		XA6SLX75	5.27	N/A	6.12	N/A	ns
		XA6SLX75T	5.27	N/A	6.12	N/A	ns
		XA6SLX100	N/A	N/A	6.80	N/A	ns
		XQ6SLX75	N/A	N/A	6.12	8.32	ns
		XQ6SLX75T	5.27	N/A	6.12	N/A	ns
		XQ6SLX150	N/A	N/A	5.88	8.13	ns
		XQ6SLX150T	5.21	N/A	5.88	N/A	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. PLL output jitter is included in the timing calculation.

Table 72: Global Clock Setup and Hold With DCM in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVC MOS25 Standard. ⁽¹⁾							
T _{PSDCM} / T _{PHDCM}	No Delay Global Clock and IFF ⁽²⁾ with DCM in System-Synchronous Mode	XC6SLX4	1.54/0.06	N/A	1.75/0.12	2.84/0.27	ns
		XC6SLX9	1.54/0.06	1.63/0.12	1.75/0.12	2.84/0.27	ns
		XC6SLX16	1.72/−0.18	1.87/−0.17	2.13/−0.17	2.31/0.26	ns
		XC6SLX25	1.70/−0.03	1.78/−0.02	2.00/−0.02	2.88/0.20	ns
		XC6SLX25T	1.70/0.07	1.78/0.08	2.00/0.08	N/A	ns
		XC6SLX45	1.74/−0.03	1.84/−0.02	2.02/−0.02	2.64/0.52	ns
		XC6SLX45T	1.74/−0.01	1.84/0.00	2.02/0.00	N/A	ns
		XC6SLX75	1.86/0.11	1.98/0.12	2.20/0.12	2.96/0.58	ns
		XC6SLX75T	1.86/0.11	1.98/0.12	2.20/0.12	N/A	ns
		XC6SLX100	1.64/0.07	1.72/0.08	1.97/0.08	2.70/0.99	ns
		XC6SLX100T	1.64/0.09	1.72/0.10	1.97/0.10	N/A	ns
		XC6SLX150	1.53/0.39	1.62/0.40	1.82/0.40	2.75/1.00	ns
		XC6SLX150T	1.53/0.39	1.62/0.40	1.82/0.40	N/A	ns
		XA6SLX4	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX9	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX16	1.88/0.02	N/A	2.13/0.03	N/A	ns
		XA6SLX25	1.80/0.16	N/A	2.05/0.17	N/A	ns
		XA6SLX25T	1.80/0.16	N/A	2.13/0.17	N/A	ns
		XA6SLX45	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX45T	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX75	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX100	N/A	N/A	2.46/0.24	N/A	ns
		XQ6SLX75	N/A	N/A	2.20/0.12	2.96/0.58	ns
		XQ6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XQ6SLX150	N/A	N/A	1.82/0.56	2.75/1.00	ns
		XQ6SLX150T	1.65/0.55	N/A	1.82/0.56	N/A	ns

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFIO2

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Data Input Setup and Hold Times Relative to a Forwarded Clock Input Pin Using BUFIO2							
T _{PSCS} /T _{PHCS}	IFF setup/hold using BUFIO2 clock	XC6SLX4	0.57/0.94	N/A	0.95/1.12	0.27/1.56	ns
		XC6SLX9	0.40/0.95	0.50/0.96	0.60/1.12	0.27/1.56	ns
		XC6SLX16	0.48/0.74	0.55/0.75	0.69/0.83	1.27/1.31	ns
		XC6SLX25	0.28/1.02	0.28/1.12	0.28/1.24	0.15/1.78	ns
		XC6SLX25T	0.28/1.02	0.28/1.12	0.28/1.24	N/A	ns
		XC6SLX45	0.42/1.19	0.44/1.29	0.50/1.40	0.12/1.83	ns
		XC6SLX45T	0.42/1.19	0.44/1.29	0.50/1.40	N/A	ns
		XC6SLX75	0.38/1.48	0.38/1.63	0.38/1.84	0.05/2.78	ns
		XC6SLX75T	0.38/1.48	0.38/1.63	0.38/1.84	N/A	ns
		XC6SLX100	0.06/1.48	0.06/1.63	0.06/1.87	−0.03/2.72	ns
		XC6SLX100T	0.06/1.48	0.06/1.63	0.06/1.87	N/A	ns
		XC6SLX150	0.04/1.73	0.04/1.75	0.04/1.98	−0.08/3.07	ns
		XC6SLX150T	0.04/1.73	0.04/1.75	0.04/1.98	N/A	ns
		XA6SLX4	0.64/0.96	N/A	0.97/1.12	N/A	ns
		XA6SLX9	0.44/0.99	N/A	0.62/1.16	N/A	ns
		XA6SLX16	0.50/0.78	N/A	0.69/0.83	N/A	ns
		XA6SLX25	0.28/1.04	N/A	0.28/1.25	N/A	ns
		XA6SLX25T	0.28/1.04	N/A	0.28/1.25	N/A	ns
		XA6SLX45	0.43/1.21	N/A	0.50/1.40	N/A	ns
		XA6SLX45T	0.43/1.21	N/A	0.50/1.40	N/A	ns
		XA6SLX75	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XA6SLX75T	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XA6SLX100	N/A	N/A	1.01/1.63	N/A	ns
		XQ6SLX75	N/A	N/A	0.38/1.84	0.05/2.78	ns
		XQ6SLX75T	0.38/1.49	N/A	0.38/1.84	N/A	ns
		XQ6SLX150	N/A	N/A	0.04/1.98	−0.08/3.07	ns
		XQ6SLX150T	0.04/1.75	N/A	0.04/1.98	N/A	ns

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFIO2 (Cont'd)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Pin-to-Pin Clock-to-Out Using BUFIO2							
T _{ICKO} FCS	OFF clock-to-out using BUFIO2 clock	XC6SLX4	5.51	N/A	6.95	8.45	ns
		XC6SLX9	5.51	5.89	6.95	8.45	ns
		XC6SLX16	5.31	5.70	6.67	8.21	ns
		XC6SLX25	5.53	6.00	7.02	8.72	ns
		XC6SLX25T	5.53	6.00	7.02	N/A	ns
		XC6SLX45	5.76	6.18	7.22	8.77	ns
		XC6SLX45T	5.76	6.18	7.22	N/A	ns
		XC6SLX75	5.94	6.46	7.57	9.72	ns
		XC6SLX75T	5.94	6.46	7.57	N/A	ns
		XC6SLX100	6.09	6.53	7.60	9.66	ns
		XC6SLX100T	6.09	6.53	7.60	N/A	ns
		XC6SLX150	6.29	6.69	7.81	9.94	ns
		XC6SLX150T	6.29	6.69	7.81	N/A	ns
		XA6SLX4	5.83	N/A	6.95	N/A	ns
		XA6SLX9	5.83	N/A	6.95	N/A	ns
		XA6SLX16	5.65	N/A	6.68	N/A	ns
		XA6SLX25	5.85	N/A	7.03	N/A	ns
		XA6SLX25T	5.85	N/A	7.03	N/A	ns
		XA6SLX45	6.07	N/A	7.25	N/A	ns
		XA6SLX45T	6.07	N/A	7.25	N/A	ns
		XA6SLX75	6.26	N/A	7.57	N/A	ns
		XA6SLX75T	6.26	N/A	7.57	N/A	ns
		XA6SLX100	N/A	N/A	7.48	N/A	ns
		XQ6SLX75	N/A	N/A	7.57	9.72	ns
		XQ6SLX75T	6.26	N/A	7.57	N/A	ns
		XQ6SLX150	N/A	N/A	7.81	9.94	ns
		XQ6SLX150T	6.62	N/A	7.81	N/A	ns

Date	Version	Description of Revisions
06/14/10	1.5	In Table 2, added note 5 and added temperature range to V_{FS} and R_{FUSE}. Removed speed grade delineation, revised I_{RPD} description, and updated note 2 in Table 4. Added note 2 to Table 7. Added $DIFF_MOBILE_DDR$ to Table 8 and Table 10. Added note 4 to Table 15. Changed minimum DV_{PPIN} in Table 16. Updated $F_{GTPDRCLK}$ in Table 19. Increased maximum T_{LLSKEW} in Table 22. Updated descriptions and added data to Table 23. Removed note 1 and added new data to the Networking Applications section in Table 25. Updated Table 26 and Table 27 to the data in ISE v12.1 software with speed specification v1.08. In Table 28, added $DIFF_MOBILE_DDR$ and updated -4 speed grade data. Updated the maximum I/O pairs per bank in Table 33. Updated note 2 on Table 39. Revised the F_{MAX} in Table 44. In Table 47, updated description for $T_{SMCKCSO}$, revised values for T_{POR} and added Min value, added $T_{BPIICCK}$ and $T_{SPIICCK}$. Also in Table 47, added device dependencies to F_{SMCKCK} and F_{RBCKCK}. Updated and added data to Table 63 through Table 78, and Table 81. In Table 79, added data on the XC6SLX45-FG(G)676 and revised the XC6SLX45T and XC6SLX150T values. The following changes to this specification are addressed in the product change notice XC6SLX45-FG(G)676, <i>MCB Performance and JTAG Revision Code for Spartan-6 LX16 and LX45 FPGAs</i>. In Table 2, revised the V_{CCINT} to add the memory controller block extended performance specifications. In Table 25, changed the standard specifications and added extended performance specifications for the memory controller block and note 2. Added note 4 and updated values in Table 34.
06/24/10	1.6	Production release of XC6SLX45T (-2 and -3 speed grades), XC6SLX16 and XC6SLX45 (-3 speed grade) devices which includes changes to Table 26 and Table 27 (ISE v12.1 software with speed specification v1.08). Added the -3N speed grade, which designates Spartan-6 devices that do not support MCB functionality. This includes changes to Table 2 (note 2), Table 25 (note 4), and Switching Characteristics (Table 26). Updated Simultaneously Switching Outputs discussion. Added -3 speed grade values for T_{TAP} and F_{MINCAL} values in Table 39. In Table 40, updated T_{RPW} (-2 and -3 speed grade) values and F_{TOG} (-3 speed grade) values. In Table 48, updated T_{GIO} (-2 and -3 speed grade) values. Updated -3 values in spread spectrum section of Table 57.
07/16/10	1.7	Production release of specific devices listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 4 advising designers of the patch which contains v1.11. Also updated the -1L speed specification to v1.04. Updated numerous -4 and -1L values. Added -4 T_{TAP} values and F_{MINCAL} to Table 39. Revised T_{CINCK}/T_{CKCIN} in Table 40. In Table 41, revised T_{SHCKO}. In Table 42, revised T_{REQ}. Added new -1L values to Table 47. Added and updated values in Table 79.
07/26/10	1.8	Production release of XC6SLX25, XC6SLX25T, XC6SLX100 and XC6SLX100T in the specific speed grades listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 7 to Table 2 and moved V_{FS} and R_{FUSE} to a new Table 3. Added I_{HS} and note 4 to Table 4. Added note 1 to Table 28. Added and updated SSO limits per V_{CCO}/GND pairs in Table 34. Added note 3 to Table 47. In Table 54, removed -1L specifications for $CLKOUT_PER_JITT_DV1/2$ and revised $CLKIN_CLKFB_PHASE$ and $CLKOUT_PHASE_DLL$ values. Updated note 3 in both Table 56 and Table 57.
08/23/10	1.9	Updated values for $F_{GTPRANGE1}$, $F_{GTPRANGE2}$, and $F_{GPLLMIN}$ in Table 18. Revised -3 and -4 values in Table 21. Removed the -1L speed grade readback support restriction and note 3 in Table 47.
11/05/10	1.10	Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in Table 26 and Table 27 using ISE v12.3 software with speed specification v1.12 for the -2 speed grade available in the 12.3 <i>Speed Files Patch</i>. Added note 3 advising designers of the patch which contains v1.12. In Table 2, added note 4. In Table 4, added note 2. In Table 10, added notes 2 and 3. In Table 44, added note 2. In Table 47, updated symbol for $T_{SMWCKCK}/T_{SMCKCKW}$, changed -1L values for $T_{USERCCLKH}$ and $T_{USERCCLKL}$, and added and revised the modes for F_{MCKCK} and F_{SMCKCK}. In Table 53, redefined and expanded description for $CLKIN_FREQ_DLL$ and rewrote note 3. Updated title of Table 58. Also in Table 78, revised T_{DCD_CLK} for XC6SLX150 and XC6SLX150T. Changed description of T_{PSFD}/T_{PHFD} in Table 71. For the -1L speed grade, updated data sheet to ISE 12.3 software with speed specification v1.05 which revised the values in the following tables: Table 25, Table 28, Table 35, Table 36, Table 37, Table 40 through Table 43, Table 48 through Table 56, Table 62 through Table 78, Table 80, and Table 81. Updated Notice of Disclaimer.